

# DATA SHEET

## **BLU56** UHF power transistor

Product specification

January 1991

**UHF power transistor****BLU56****FEATURES**

- SMD encapsulation
- Emitter-ballasting resistors for optimum temperature profile
- Gold metallization ensures excellent reliability.

**DESCRIPTION**

NPN silicon planar epitaxial transistor encapsulated in a SOT223 surface mounted envelope and designed primarily for use in mobile radio equipment in the 470 MHz communications band.

**PINNING - SOT223**

PIN	DESCRIPTION
1	emitter
2	base
3	emitter
4	collector

**QUICK REFERENCE DATA**

RF performance at  $T_s \leq 60^\circ\text{C}$  in a common emitter class-B test circuit (see note 1).

MODE OF OPERATION	f (MHz)	V <sub>CE</sub> (V)	P <sub>L</sub> (W)	G <sub>p</sub> (dB)	η <sub>c</sub> (%)
c.w. narrow band	470	12.5	1	> 12	> 50

**Note**

1.  $T_s$  = temperature at soldering point of collector tab.

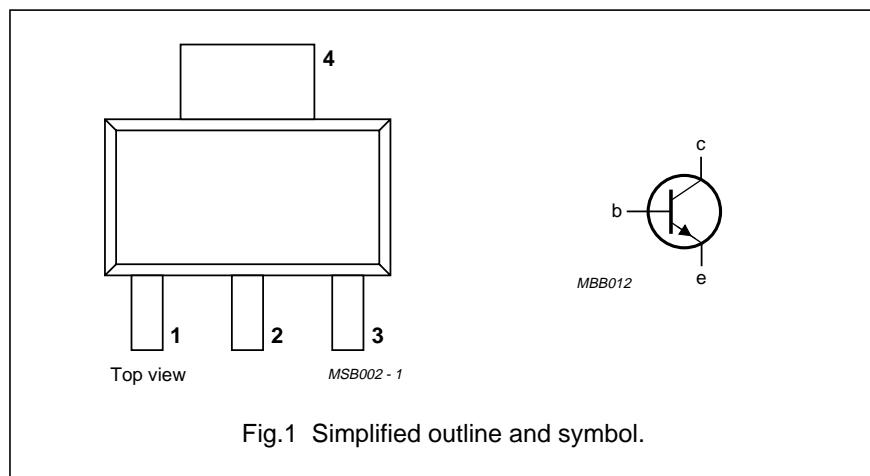
**PIN CONFIGURATION**

Fig.1 Simplified outline and symbol.

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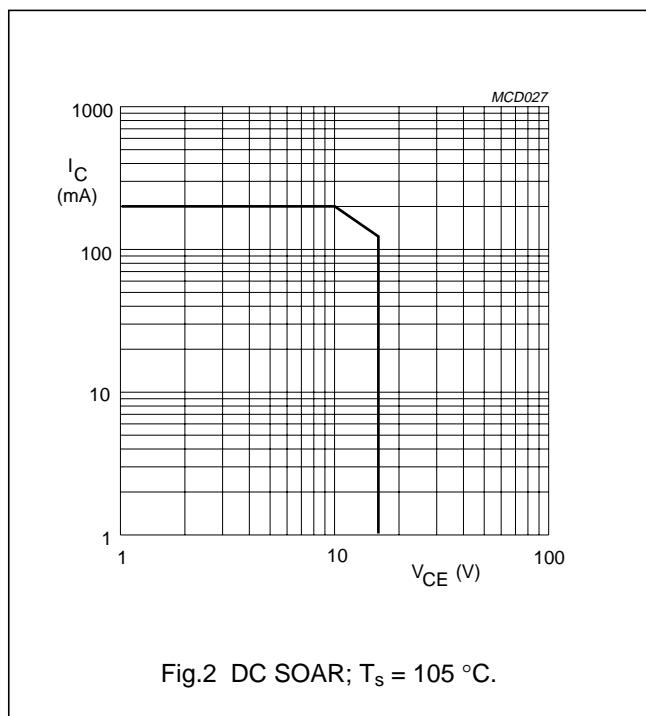
**LIMITING VALUES**

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	36	V
$V_{CEO}$	collector-emitter voltage	open base	–	16	V
$V_{EBO}$	emitter-base voltage	open collector	–	3	V
$I_C, I_{C(AV)}$	collector current	DC or average value	–	200	mA
$I_{CM}$	collector current	peak value $f > 1 \text{ MHz}$	–	600	mA
$P_{\text{tot}}$	total power dissipation	$f > 1 \text{ MHz}$ $T_s = 105 \text{ }^{\circ}\text{C}$ (note 1)	–	2	W
$T_{\text{stg}}$	storage temperature range		–65	150	$^{\circ}\text{C}$
$T_j$	operating junction temperature		–	175	$^{\circ}\text{C}$

**Note**

1.  $T_s$  = temperature at soldering point of collector tab.

**THERMAL RESISTANCE**

SYMBOL	PARAMETER	MAX.	UNIT
$R_{\text{th j-s}}(\text{DC})$	from junction to soldering point	35	K/W

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## CHARACTERISTICS

 $T_j = 25^\circ\text{C}$ .

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(\text{BR})\text{CBO}}$	collector-base breakdown voltage	open emitter $I_C = 2.5 \text{ mA}$	36	—	—	V
$V_{(\text{BR})\text{CEO}}$	collector-emitter breakdown voltage	open base $I_C = 10 \text{ mA}$	16	—	—	V
$V_{(\text{BR})\text{EBO}}$	emitter-base breakdown voltage	open collector $I_E = 0.5 \text{ mA}$	3	—	—	V
$I_{\text{CES}}$	collector-emitter leakage current	$V_{\text{BE}} = 0$ $V_{\text{CE}} = 16 \text{ V}$	—	—	1	mA
$h_{\text{FE}}$	DC current gain	$V_{\text{CE}} = 10 \text{ V}$ $I_C = 150 \text{ mA}$	25	—	—	
$E_{\text{SBR}}$	second breakdown energy	$L = 25 \text{ mH}$ $R_{\text{BE}} = 10 \Omega$ $f = 50 \text{ Hz}$	0.3	—	—	mJ
$C_c$	collector capacitance	$V_{\text{CB}} = 12.5 \text{ V}$ $I_E = I_e = 0$ $f = 1 \text{ MHz}$	—	2.2	3	pF
$C_{\text{re}}$	feedback capacitance	$V_{\text{CE}} = 12.5 \text{ V}$ $I_C = 0$ $f = 1 \text{ MHz}$	—	1.2	2	pF

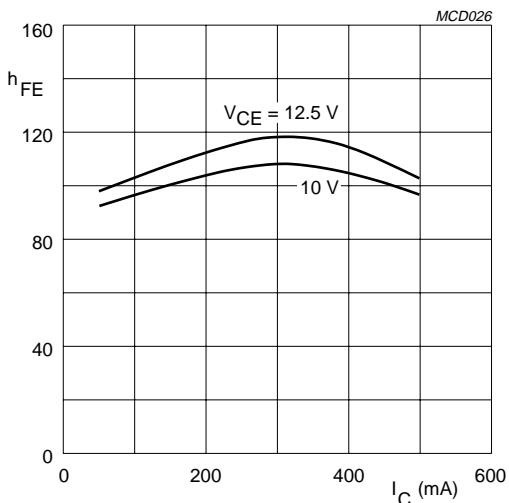
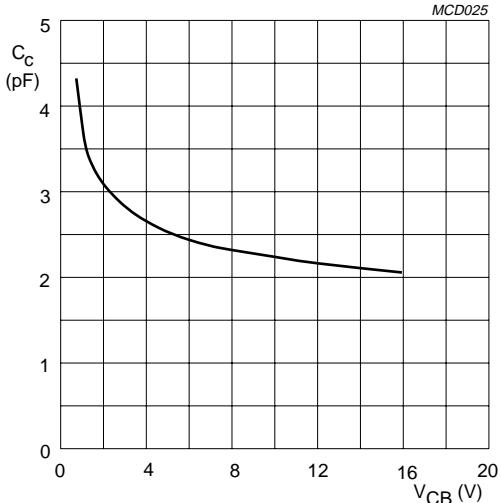


Fig.3 DC current gain as a function of drain current; typical values.

Fig.4 Collector capacitance as a function of collector-base voltage;  $I_E = I_e = 0$ ;  $f = 1 \text{ MHz}$ ; typical values.

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**APPLICATION INFORMATION**RF performance at  $T_s \leq 60^\circ\text{C}$ ; in a common emitter class-B test circuit.

MODE OF OPERATION	f (MHz)	V <sub>CE</sub> (V)	P <sub>L</sub> (W)	G <sub>p</sub> (dB)	$\eta_c$ (%)
c.w. narrow band	470	12.5	1	> 12 typ. 14	> 50 typ. 58

**Ruggedness in class-B operation**

The BLU56 is capable of withstanding a load mismatch corresponding to VSWR = 50:1 through all phases at rated output power, up to a supply voltage of 15.5 V, f = 470 MHz and  $T_s \leq 60^\circ\text{C}$ .

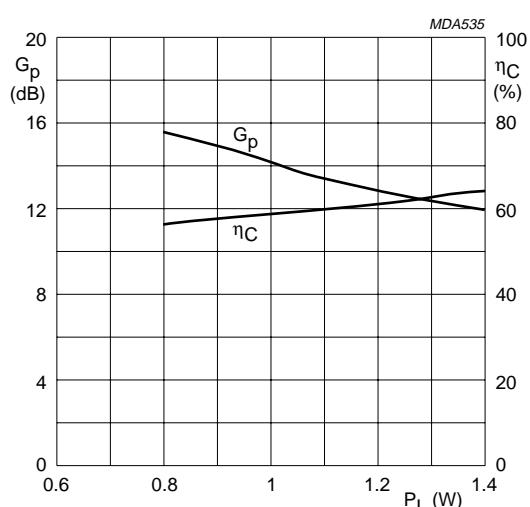


Fig.5 Gain and efficiency as functions of load power; typical values.

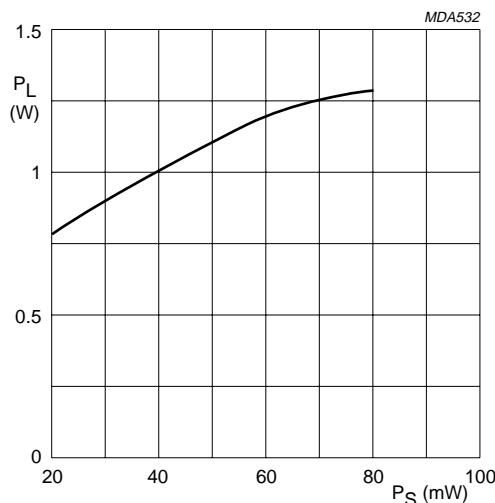


Fig.6 Load power as a function of drive power; typical values.

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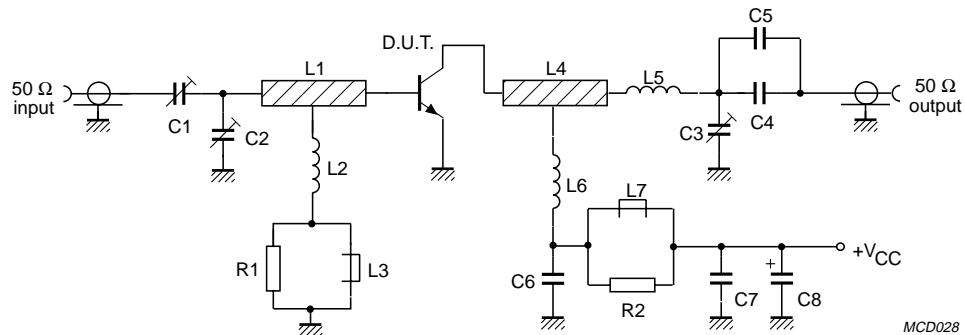


Fig.7 Class-B test circuit at f = 470 MHz.

## List of components (see test circuit)

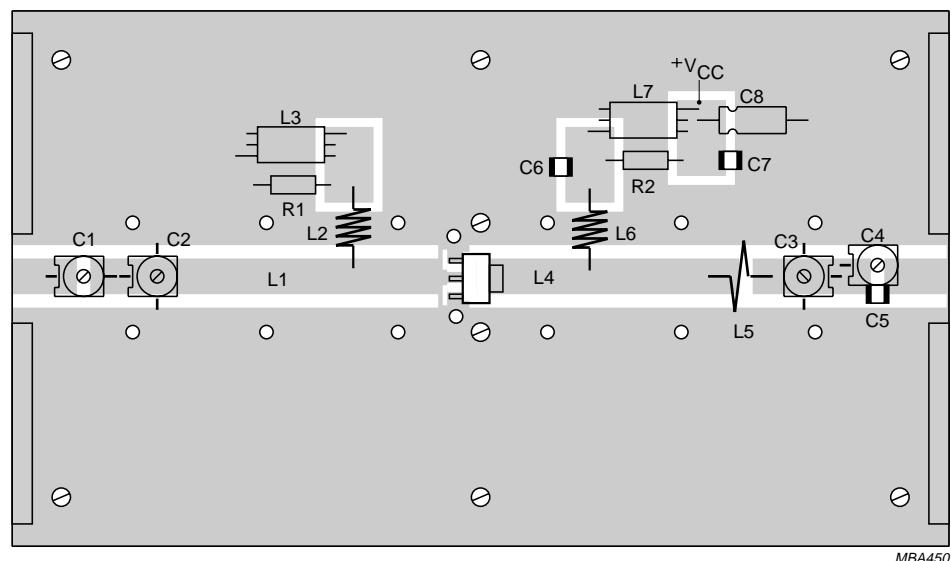
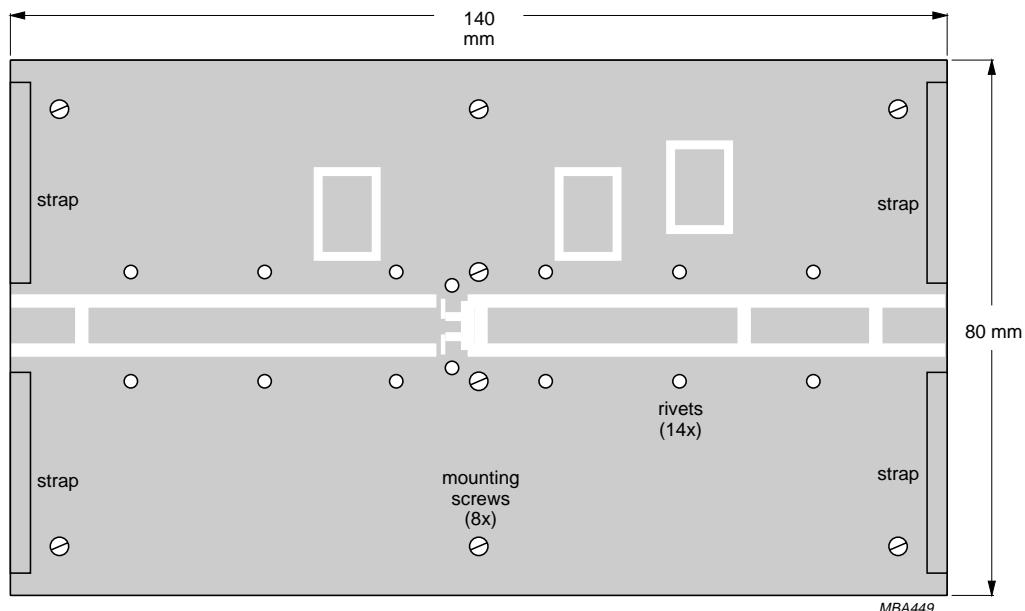
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C4	film dielectric trimmer	2 to 18 pF		2222 809 05217
C2, C3	film dielectric trimmer	2 to 9 pF		2222 809 09002
C5	multilayer ceramic chip capacitor (note 1)	10 pF		
C6	multilayer ceramic chip capacitor (note 1)	100 pF		
C7	multilayer ceramic chip capacitor (note 1)	1 nF		
C8	63 V electrolytic capacitor	2.2 µF		
L1	stripline (note 2)	50 Ω	54 mm × 4.7 mm	
L2, L6	4 turns enamelled 0.4 mm copper wire	50 nH	int. dia. 3 mm	
L3, L7	grade 3B1 Ferroxcube wideband RF choke			4312 020 36640
L4	stripline (note 2)	50 Ω	36 mm × 4.7 mm	
L5	1 turn enamelled 2.2 mm copper wire	20 nH	int. dia. 8 mm	
R1, R2	0.25 W metal film resistor	10 Ω, 5%		

## Notes

1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
2. The striplines are mounted on a double copper-clad printed circuit board, with PTFE fibre-glass dielectric ( $\epsilon_r = 2.2$ ); thickness  $\frac{1}{16}$  inch.

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The circuit and components are situated on one side of a copper-clad PTFE fibre-glass board; the other side is unetched and serves as a ground plane. Earth connections from the component side to the ground plane are made by means of fixing screws, hollow rivets and copper foil straps, as shown.

Fig.8 Component layout for 470 MHz class-B test circuit.

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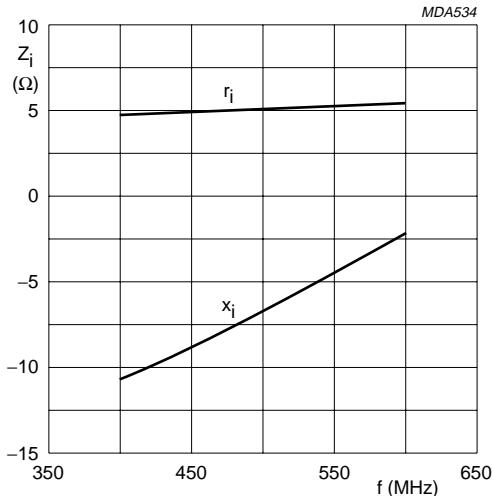


Fig.9 Input impedance (series components) as a function of frequency;  
class-B operation;  $V_{CE} = 12.5$  V;  $P_L = 1$  W;  
typical values.

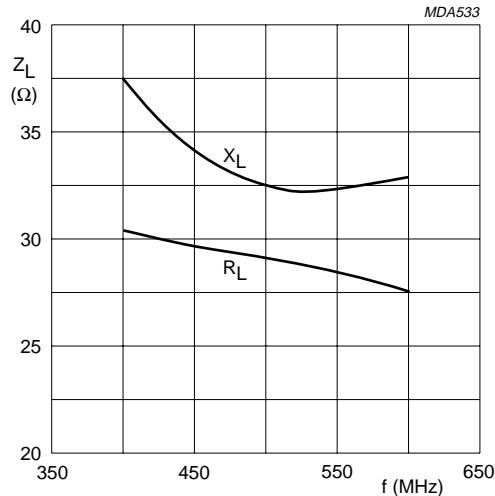


Fig.10 Load impedance (series components) as a function of frequency;  
class-B operation;  $V_{DS} = 12.5$  V;  $P_L = 1$  W;  
typical values.

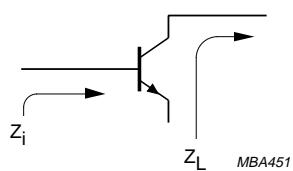


Fig.11 Definition of transistor impedance.

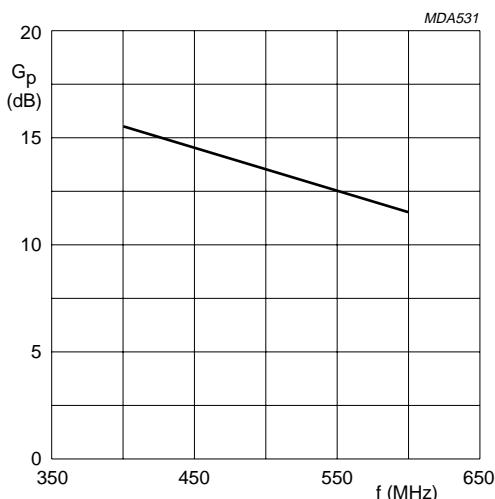


Fig.12 Power gain as a function of frequency;  
class-B operation;  $V_{DS} = 12.5$  V;  $P_L = 1$  W;  
typical values.

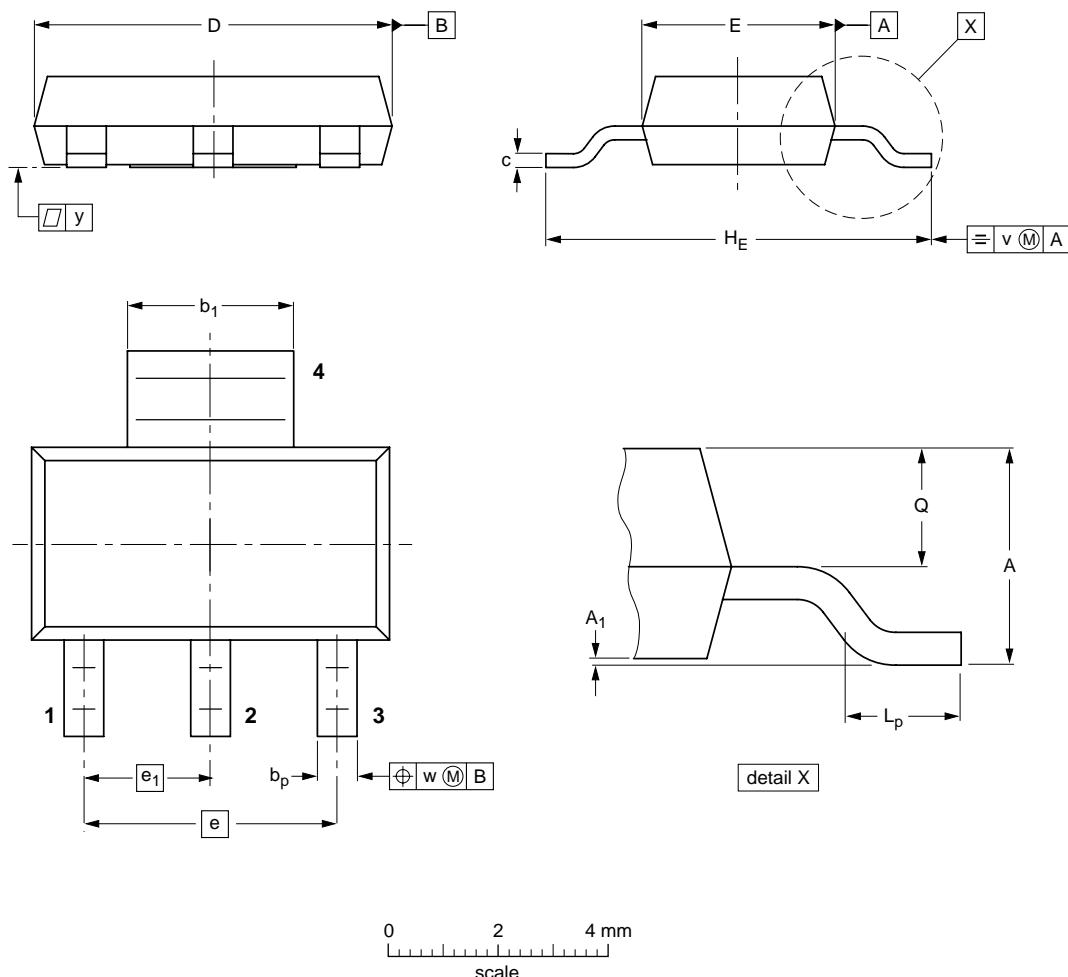
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## PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



## DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub>	b <sub>p</sub>	b <sub>1</sub>	c	D	E	e	e <sub>1</sub>	H <sub>E</sub>	L <sub>p</sub>	Q	v	w	y
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT223						-96-11-11 97-02-28

**UHF power transistor****BLU56****DEFINITIONS**

<b>Data Sheet Status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

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